



PMPB10XNE

20 V, single N-channel Trench MOSFET

30 November 2012

Product data sheet

1. Product profile

1.1 General description

N-channel enhancement mode Field-Effect Transistor (FET) in a leadless medium power DFN2020MD-6 (SOT1220) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

1.2 Features and benefits

- 2.2 kV ESD protection
- Small and leadless ultra thin SMD plastic package: 2 x 2 x 0.65 mm
- Exposed drain pad for excellent thermal conduction
- Tin-plated, 100% solderable side pads for optical solder inspection

1.3 Applications

- Charging switch for portable devices
- DC-to-DC converters
- Power management in battery-driven portables
- Hard disk and computing power management

1.4 Quick reference data

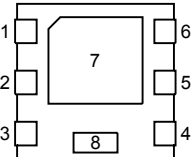
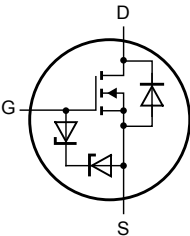
Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------|----------------------------------|--|-----|-----|------|------------|
| V_{DS} | drain-source voltage | $T_j = 25\text{ °C}$ | - | - | 20 | V |
| V_{GS} | gate-source voltage | | -12 | - | 12 | V |
| I_D | drain current | $V_{GS} = 4.5\text{ V}; T_{amb} = 25\text{ °C}; t \leq 5\text{ s}$ | [1] | - | 12.9 | A |
| Static characteristics | | | | | | |
| R_{DSon} | drain-source on-state resistance | $V_{GS} = 4.5\text{ V}; I_D = 9\text{ A}; T_j = 25\text{ °C}$ | - | 10 | 14 | m Ω |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm².

2. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|---|--|
| 1 | D | drain |  <p>Transparent top view DFN2020MD-6 (SOT1220)</p> |  <p>017aaa255</p> |
| 2 | D | drain | | |
| 3 | G | gate | | |
| 4 | S | source | | |
| 5 | D | drain | | |
| 6 | D | drain | | |
| 7 | D | drain | | |
| 8 | S | source | | |

3. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|-------------|-------------|--|---------|
| | Name | Description | Version |
| PMPB10XNE | DFN2020MD-6 | plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals | SOT1220 |

4. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PMPB10XNE | 1H |

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|-----------|-------------------------|--|-----|-----|------|------|
| V_{DS} | drain-source voltage | $T_j = 25\text{ °C}$ | | - | 20 | V |
| V_{GS} | gate-source voltage | | | -12 | 12 | V |
| I_D | drain current | $V_{GS} = 4.5\text{ V}; T_{amb} = 25\text{ °C}; t \leq 5\text{ s}$ | [1] | - | 12.9 | A |
| | | $V_{GS} = 4.5\text{ V}; T_{amb} = 25\text{ °C}$ | [1] | - | 9 | A |
| | | $V_{GS} = 4.5\text{ V}; T_{amb} = 100\text{ °C}$ | [1] | - | 5.7 | A |
| I_{DM} | peak drain current | $T_{amb} = 25\text{ °C};$ single pulse; $t_p \leq 10\text{ }\mu\text{s}$ | | - | 36 | A |
| P_{tot} | total power dissipation | $T_{amb} = 25\text{ °C}$ | [1] | - | 1.7 | W |

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---------------------------|---------------------------------|---|-----|-----|------|------|
| | | $T_{amb} = 25\text{ °C}; t \leq 5\text{ s}$ | [1] | - | 3.5 | W |
| | | $T_{sp} = 25\text{ °C}$ | | - | 12.5 | W |
| T_j | junction temperature | | | -55 | 150 | °C |
| T_{amb} | ambient temperature | | | -55 | 150 | °C |
| T_{stg} | storage temperature | | | -65 | 150 | °C |
| Source-drain diode | | | | | | |
| I_S | source current | $T_{amb} = 25\text{ °C}$ | [1] | - | 2 | A |
| ESD maximum rating | | | | | | |
| V_{ESD} | electrostatic discharge voltage | HBM | [2] | - | 2200 | V |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm².
- [2] Measured between all pins.

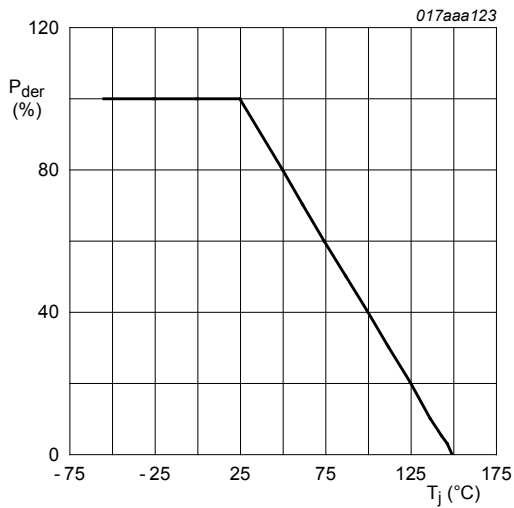


Fig. 1. Normalized total power dissipation as a function of junction temperature

$$P_{der} = \frac{P_{tot}}{P_{tot(25^\circ\text{C})}} \times 100\%$$

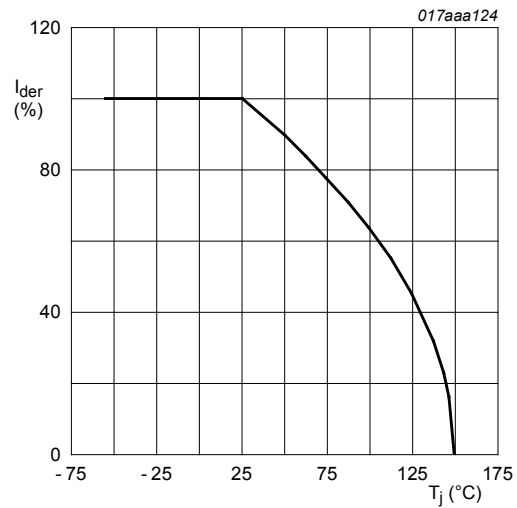
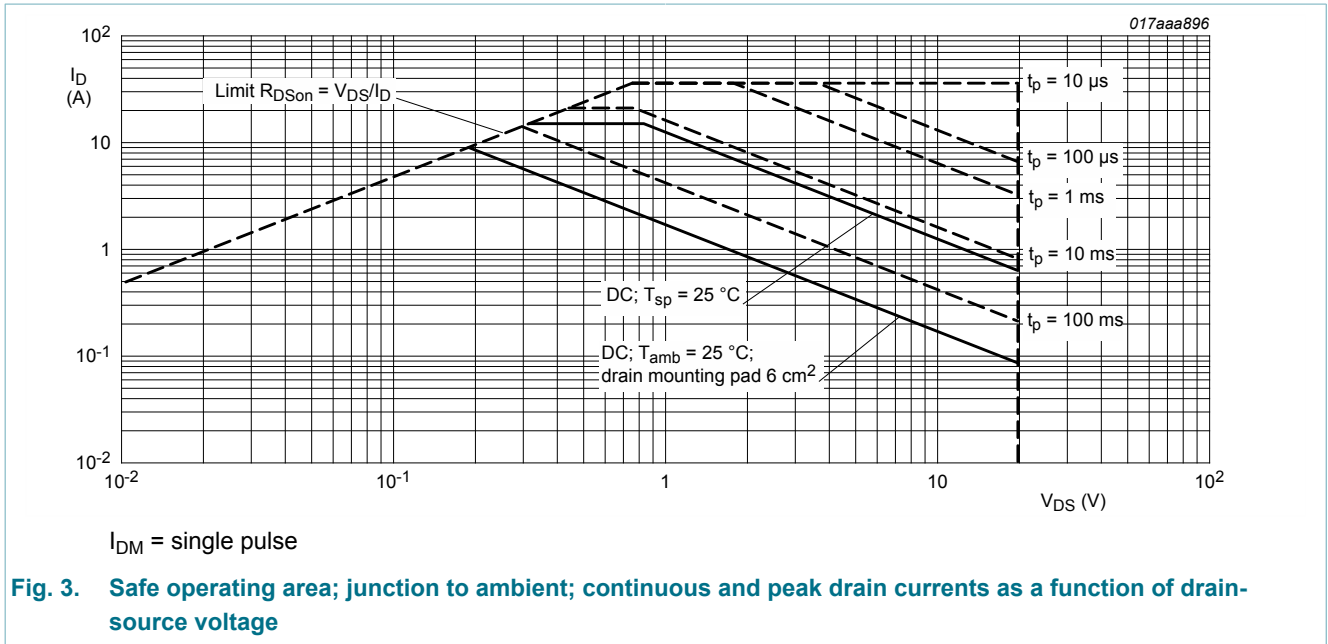


Fig. 2. Normalized continuous drain current as a function of junction temperature

$$I_{der} = \frac{I_D}{I_{D(25^\circ\text{C})}} \times 100\%$$



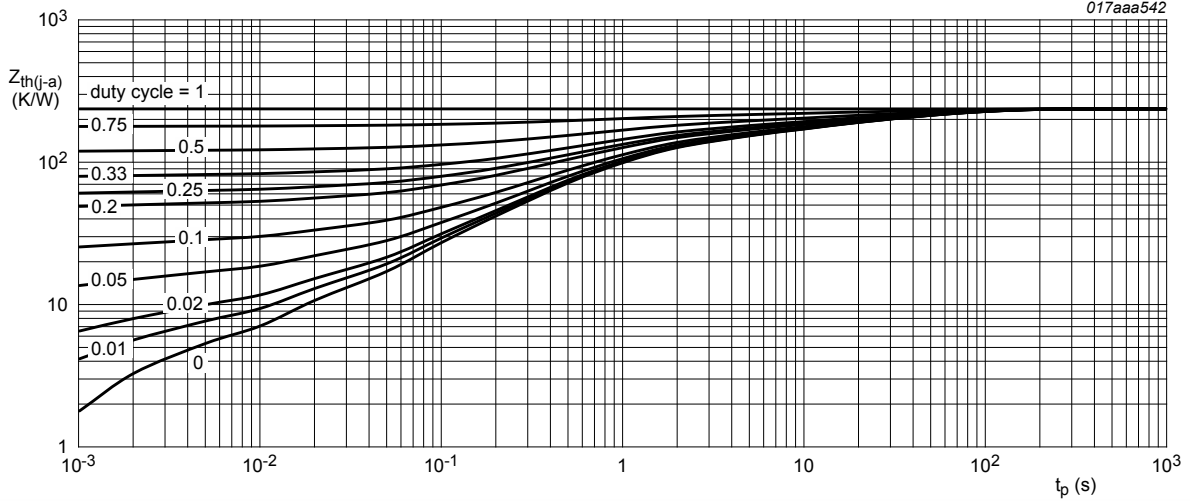
6. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|----------------|--|----------------------------------|-----|-----|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | - | 235 | 270 | K/W |
| | | | [2] | - | 67 | 74 | K/W |
| | | in free air; $t \leq 5\text{ s}$ | [2] | - | 33 | 36 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | | - | 5 | 10 | K/W |

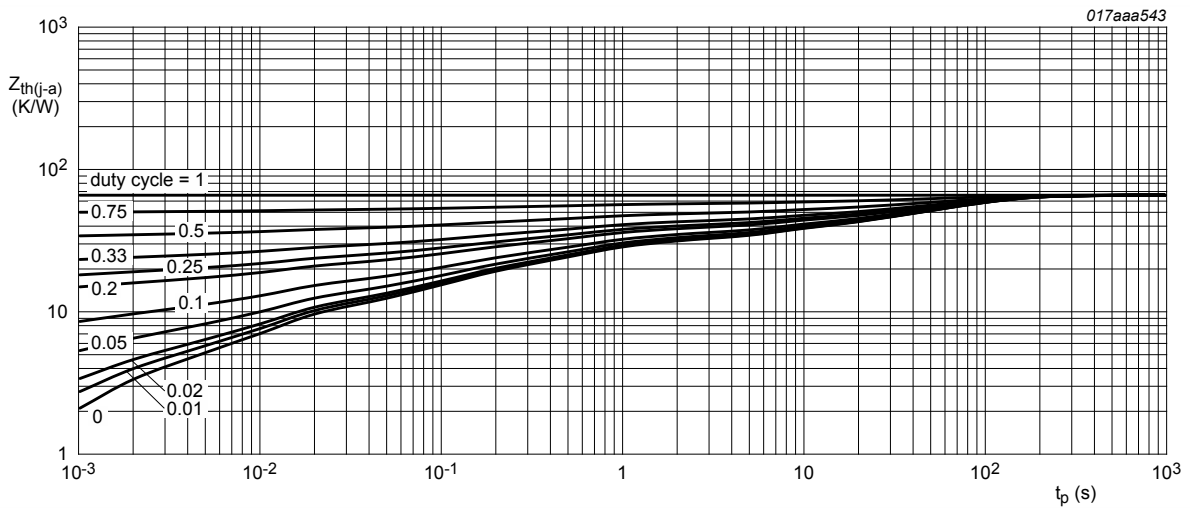
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm^2 .



FR4 PCB, standard footprint

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for drain 6 cm²

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

7. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------|--------------------------------|---|-----|------|-----|---------|
| Static characteristics | | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25 \text{ }^\circ C$ | 20 | - | - | V |
| V_{GSth} | gate-source threshold voltage | $I_D = 250 \mu A; V_{DS} = V_{GS}; T_j = 25 \text{ }^\circ C$ | 0.4 | 0.65 | 0.9 | V |
| I_{DSS} | drain leakage current | $V_{DS} = 20 V; V_{GS} = 0 V; T_j = 25 \text{ }^\circ C$ | - | - | 1 | μA |
| I_{GSS} | gate leakage current | $V_{GS} = 8 V; V_{DS} = 0 V; T_j = 25 \text{ }^\circ C$ | - | - | 10 | μA |

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------------------|----------------------------------|---|-----|------|-----|------------------|
| | | $V_{GS} = -8\text{ V}; V_{DS} = 0\text{ V}; T_j = 25\text{ }^\circ\text{C}$ | - | - | -10 | μA |
| $R_{DS(on)}$ | drain-source on-state resistance | $V_{GS} = 4.5\text{ V}; I_D = 9\text{ A}; T_j = 25\text{ }^\circ\text{C}$ | - | 10 | 14 | $\text{m}\Omega$ |
| | | $V_{GS} = 4.5\text{ V}; I_D = 9\text{ A}; T_j = 150\text{ }^\circ\text{C}$ | - | 15 | 21 | $\text{m}\Omega$ |
| | | $V_{GS} = 2.5\text{ V}; I_D = 8\text{ A}; T_j = 25\text{ }^\circ\text{C}$ | - | 12 | 18 | $\text{m}\Omega$ |
| | | $V_{GS} = 1.8\text{ V}; I_D = 3.7\text{ A}; T_j = 25\text{ }^\circ\text{C}$ | - | 16 | 25 | $\text{m}\Omega$ |
| g_{fs} | forward transconductance | $V_{DS} = 10\text{ V}; I_D = 9\text{ A}; T_j = 25\text{ }^\circ\text{C}$ | - | 60 | - | S |
| R_G | gate resistance | $f = 1\text{ MHz}$ | - | 2 | - | Ω |
| Dynamic characteristics | | | | | | |
| $Q_{G(tot)}$ | total gate charge | $V_{DS} = 10\text{ V}; I_D = 6\text{ A}; V_{GS} = 4.5\text{ V}; T_j = 25\text{ }^\circ\text{C}$ | - | 23 | 34 | nC |
| Q_{GS} | gate-source charge | | - | 2.6 | - | nC |
| Q_{GD} | gate-drain charge | | - | 4.5 | - | nC |
| C_{iss} | input capacitance | $V_{DS} = 10\text{ V}; f = 1\text{ MHz}; V_{GS} = 0\text{ V}; T_j = 25\text{ }^\circ\text{C}$ | - | 2175 | - | pF |
| C_{oss} | output capacitance | | - | 235 | - | pF |
| C_{rss} | reverse transfer capacitance | | - | 205 | - | pF |
| $t_{d(on)}$ | turn-on delay time | $V_{DS} = 10\text{ V}; I_D = 6\text{ A}; V_{GS} = 4.5\text{ V}; R_{G(ext)} = 6\text{ }\Omega; T_j = 25\text{ }^\circ\text{C}$ | - | 13 | - | ns |
| t_r | rise time | | - | 35 | - | ns |
| $t_{d(off)}$ | turn-off delay time | | - | 54 | - | ns |
| t_f | fall time | | - | 50 | - | ns |
| Source-drain diode | | | | | | |
| V_{SD} | source-drain voltage | $I_S = 2\text{ A}; V_{GS} = 0\text{ V}; T_j = 25\text{ }^\circ\text{C}$ | - | 0.6 | 1.2 | V |

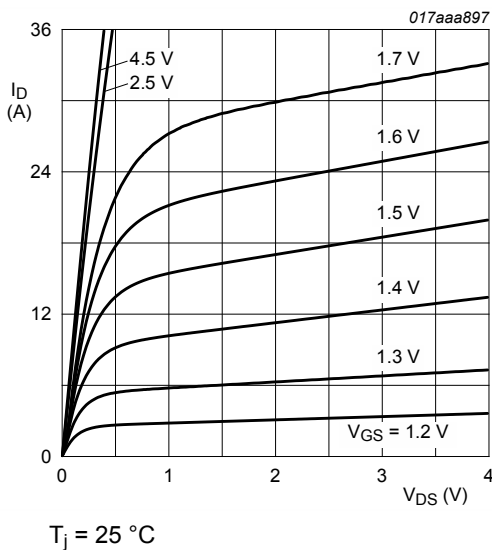


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

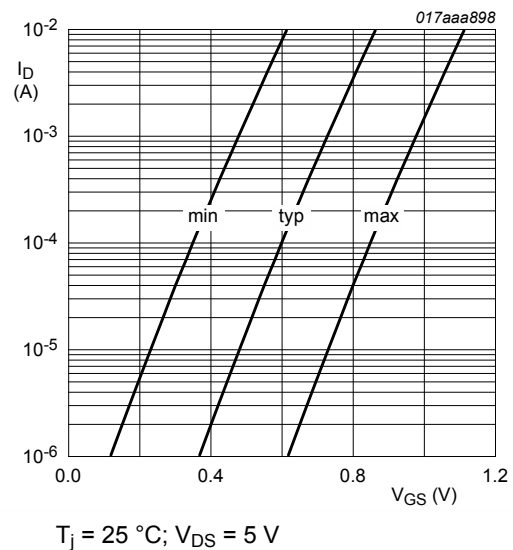


Fig. 7. Subthreshold drain current as a function of gate-source voltage

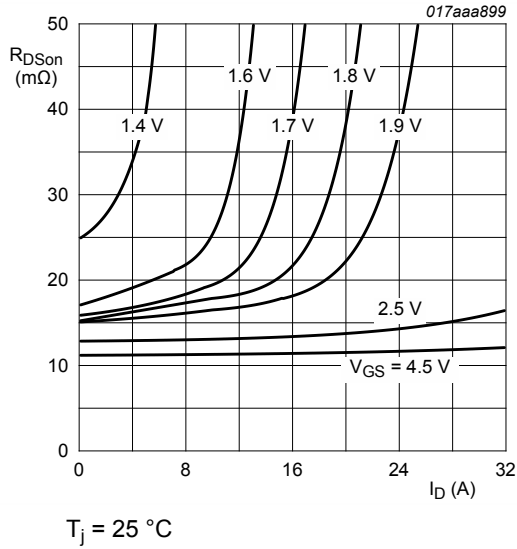


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

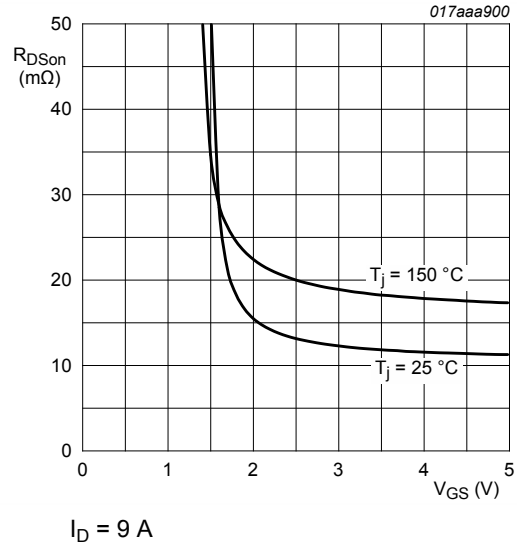


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

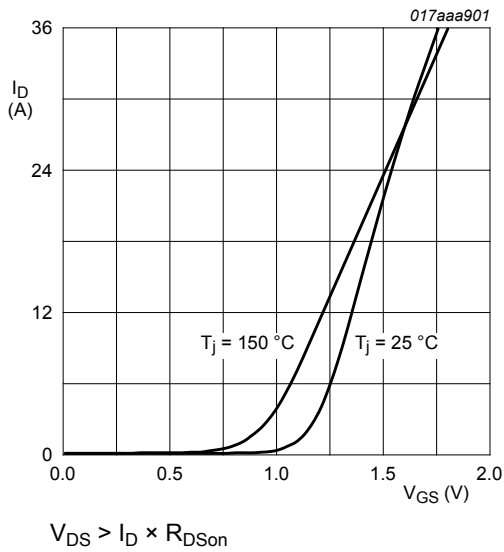


Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

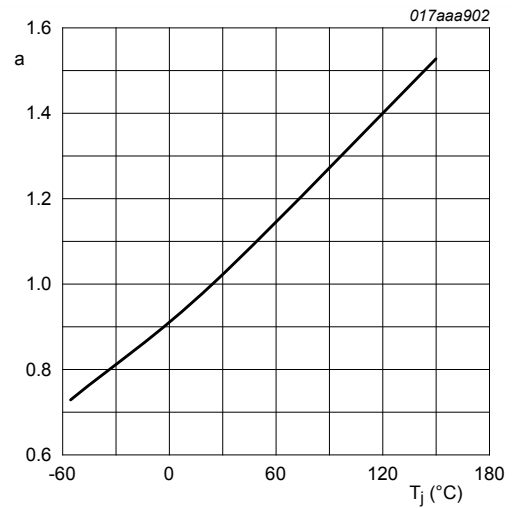


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

$$a = \frac{R_{DSon}}{R_{DSon(25^\circ\text{C})}}$$

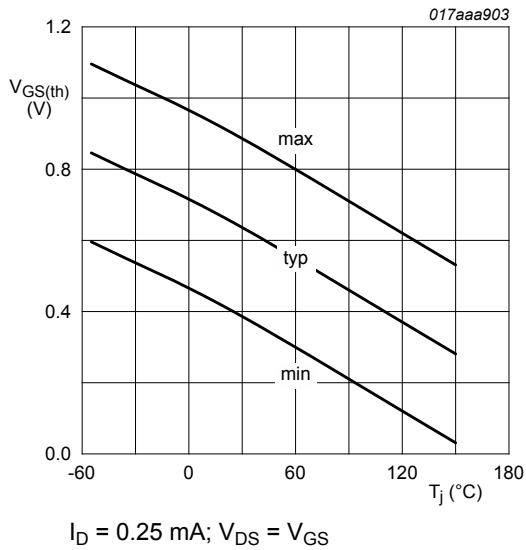


Fig. 12. Gate-source threshold voltage as a function of junction temperature

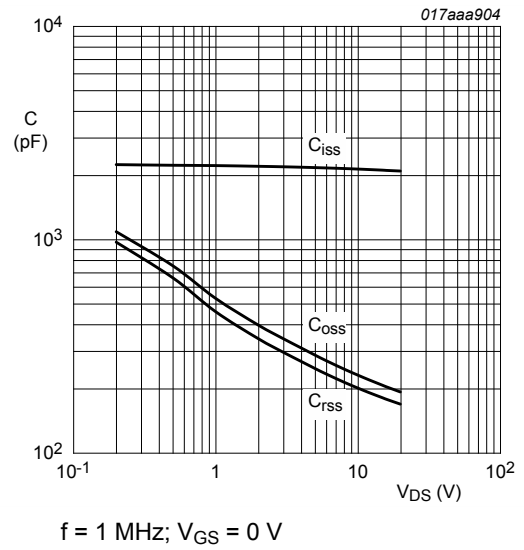


Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

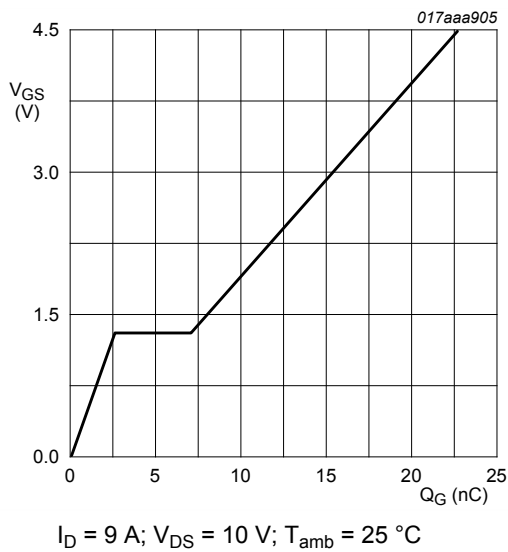


Fig. 14. Gate-source voltage as a function of gate charge; typical values

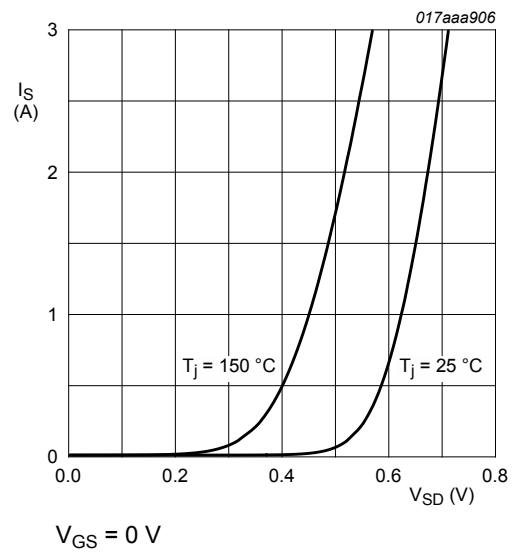


Fig. 15. Source current as a function of source-drain voltage; typical values

8. Test information

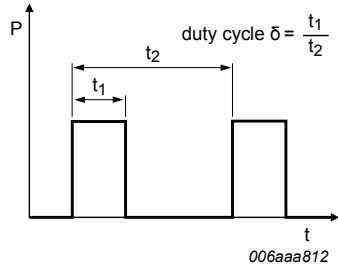


Fig. 16. Duty cycle definition

9. Package outline

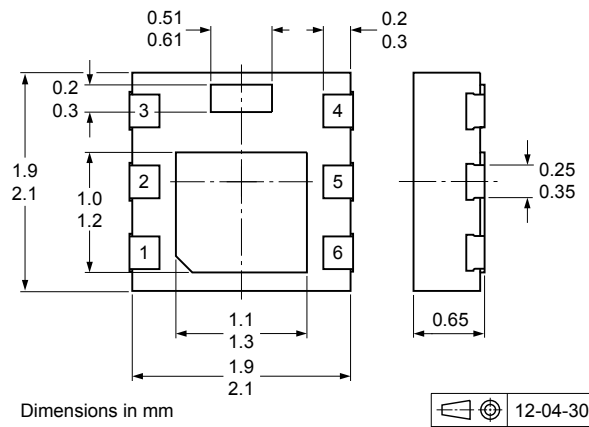


Fig. 17. Package outline DFN2020MD-6 (SOT1220)

10. Soldering

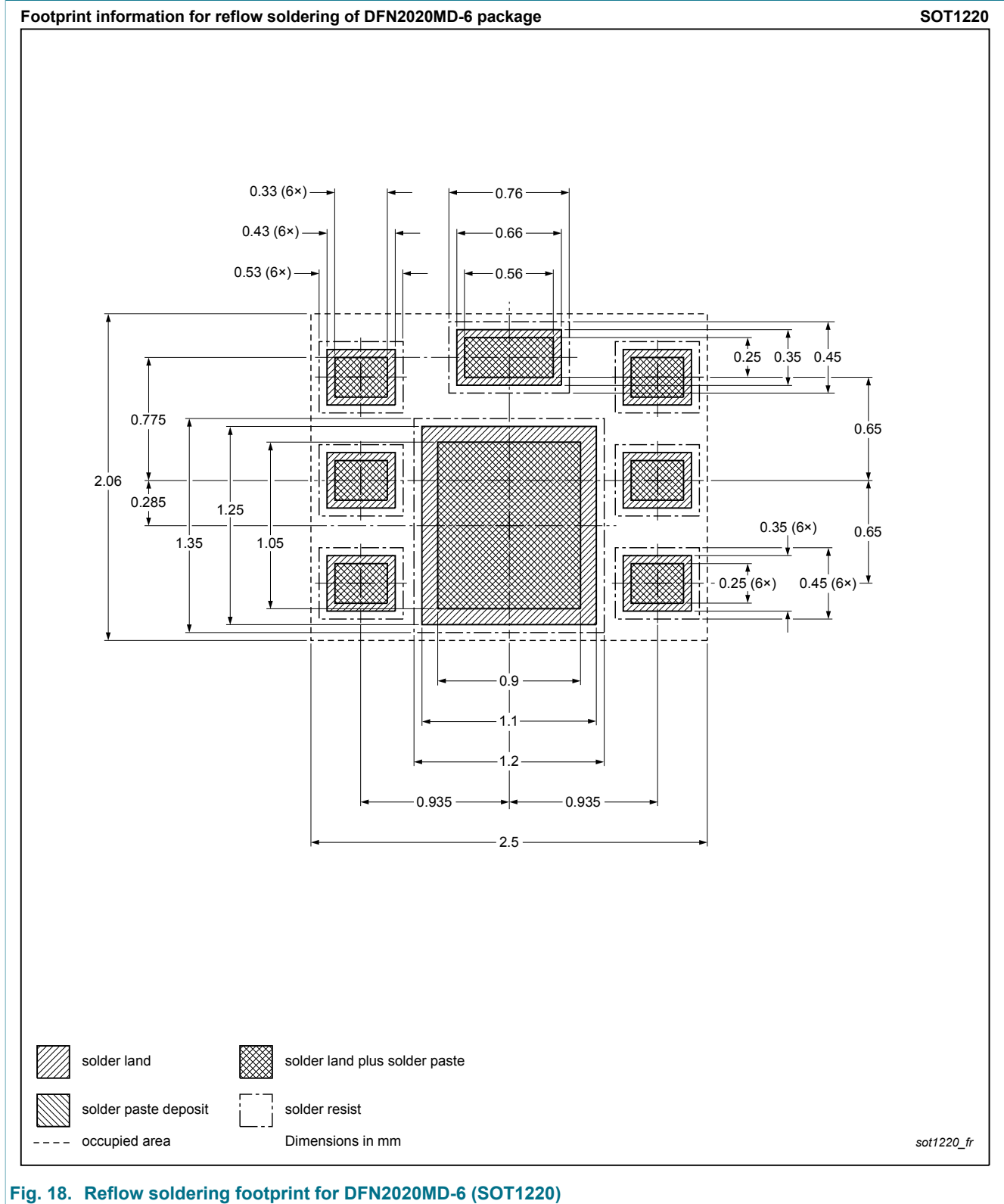


Fig. 18. Reflow soldering footprint for DFN2020MD-6 (SOT1220)

11. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|---------------|--------------|--------------------|---------------|------------|
| PMPB10XNE v.1 | 20121130 | Product data sheet | - | - |

12. Legal information

12.1 Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
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 Date of release: 30 November 2012